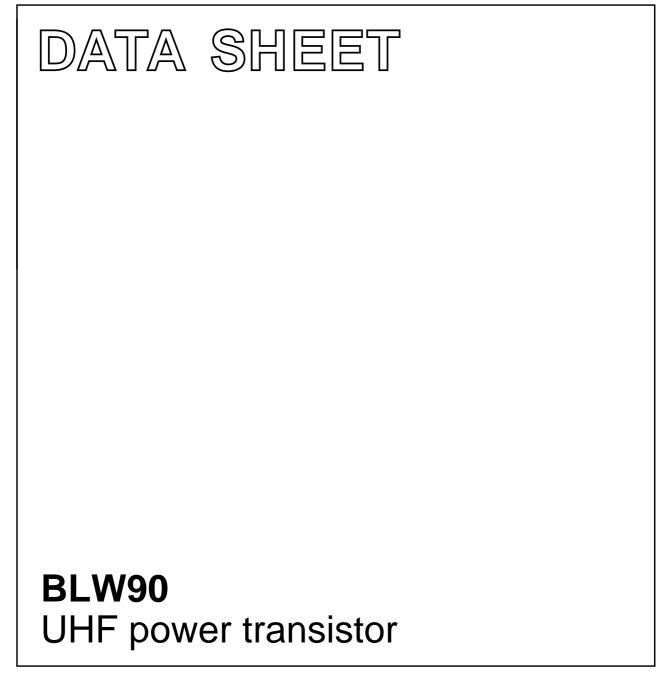
DISCRETE SEMICONDUCTORS



Product specification

August 1986



PINNING - SOT122A.

UHF power transistor

BLW90

DESCRIPTION

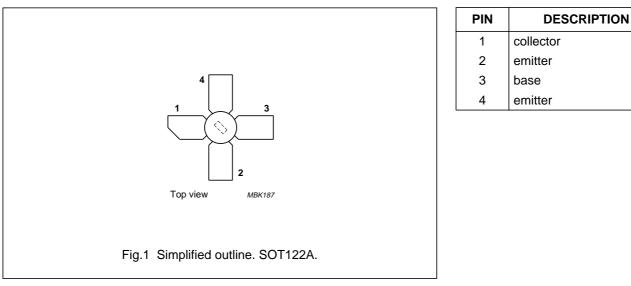
N-P-N silicon planar epitaxial transistor suitable for transmitting applications in class-A, B or C in the u.h.f. and v.h.f. range for a nominal supply voltage of 28 V. The transistor is resistance stabilized and is guaranteed to withstand infinite VSWR at rated output power. High reliability is ensured by a **gold sandwich metallization.** The transistor is housed in a $\frac{1}{4}$ " capstan envelope with a ceramic cap. All leads are isolated from the stud.

QUICK REFERENCE DATA

R.F. performance up to $T_h = 25$ °C in an unneutralized common-emitter class-B circuit

MODE OF OPERATION	V _{CE}	f	P _L	G _p	η
	V	MHz	W	dB	%
C.W.	28	470	4	> 11	> 55

PIN CONFIGURATION



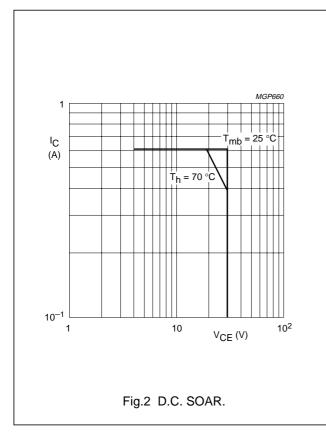
PRODUCT SAFETY This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

BLW90

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Collector-emitter voltage				
(peak value); V _{BE} = 0	V _{CESM}	max.	60	V
open base	V _{CEO}	max.	30	V
Emitter-base voltage (open collector)	V _{EBO}	max.	4	V
Collector current				
d.c. or average	I _C ; I _{C(AV)}	max.	0,62	А
(peak value); f > 1 MHz	I _{CM}	max.	2,0	А
Total power dissipation (d.c. and r.f.) up to T_{mb} = 25 °C	P _{tot}	max.	18,6	W
Storage temperature	T _{stg}	–65 to	+ 150	°C
Operating junction temperature	Tj	max.	200	°C

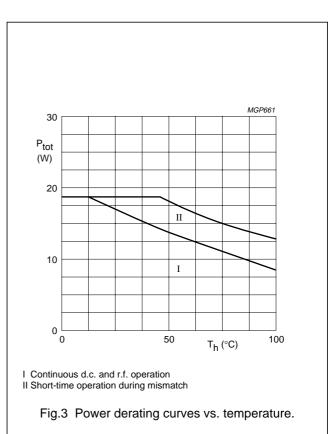


THERMAL RESISTANCE

From junction to mounting base

(d.c. and r.f. dissipation)

From mounting base to heatsink



R _{th j-mb}	=	9,0	K/W
R _{th mb-h}	=	0,6	K/W

CHARACTERISTICS

UHF power transistor

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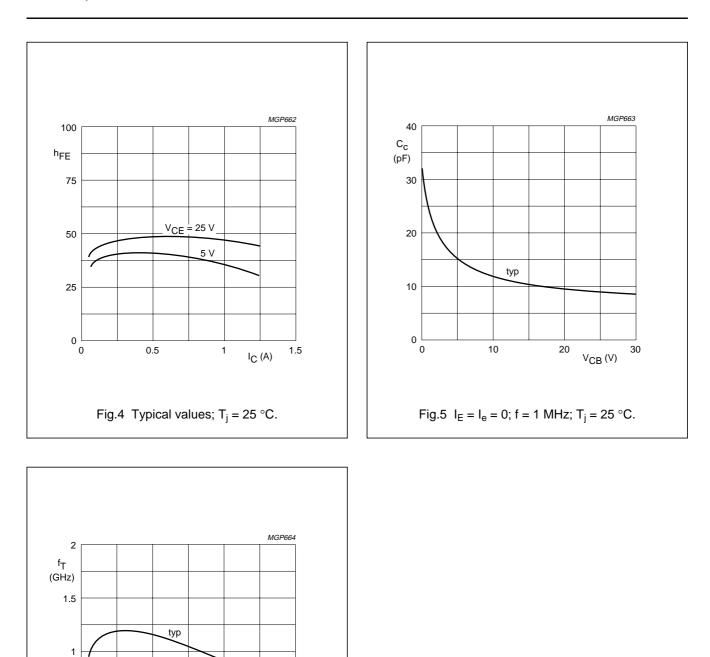
$T_j = 25 \ ^{\circ}C$				
Collector-emitter breakdown voltage				
$V_{BE} = 0; I_{C} = 4 \text{ mA}$	V _{(BR)CES}	>	60	V
Collector-emitter breakdown voltage				
open base; I _C = 20 mA	V _{(BR)CEO}	>	30	V
Emitter-base breakdown voltage				
open collector; I _E = 2 mA	V _{(BR)EBO}	>	4	V
Collector cut-off current				
$V_{BE} = 0; V_{CE} = 30 V$	I _{CES}	<	2	mA
Second breakdown energy; L = 25 mH; f = 50 Hz				
open base	E _{SBO}	>	1	mJ
$R_{BE} = 10 \ \Omega$	E _{SBR}	>	1	mJ
D.C. current gain ⁽¹⁾	b	typ.	40	
$I_{C} = 0.3 \text{ A}; V_{CE} = 5 \text{ V}$	h _{FE}	10 to	100	
Collector-emitter saturation voltage (1)				
I _C = 1,0 A; I _B = 0,2 A	V _{CEsat}	typ.	0,9	V
Transition frequency at f = 500 MHz $^{(1)}$				
$-I_{E} = 0,3 \text{ A}; V_{CB} = 28 \text{ V}$	f _T	typ.	1,2	GHz
$-I_{E} = 1,0 \text{ A}; V_{CB} = 28 \text{ V}$	f _T	typ.	0,9	GHz
Collector capacitance at f = 1 MHz				
$I_{E} = I_{e} = 0; V_{CB} = 28 V$	C _c	typ.	8,4	pF
Feedback capacitance at f = 1 MHz				
$I_{C} = 20 \text{ mA}; V_{CE} = 28 \text{ V}$	C _{re}	typ.	3,6	pF
Collector-stud capacitance	C _{cs}	typ.	1,2	pF

Note

1. Measured under pulse conditions: $t_p \leq 200 \ \mu s; \ \delta \leq 0,02.$

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UHF power transistor



0.5

0 ∟ 0

0.5

Fig.6 V_{CB} = 28 V; f = 500 MHz; T_j = 25 °C.

1

 $-I_{\mathsf{E}}(\mathsf{A})$

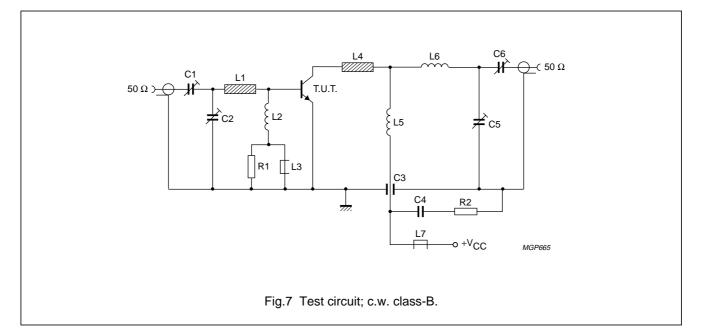
1.5

BLW90

APPLICATION INFORMATION

R.F. performance in c.w. operation (unneutralized common-emitter class-B circuit); T_h = 25 °C

f (MHz)	V _{CE} (V)	P _L (W)	P _S (W)	G _p (dB)	I _C (A)	η (%)	, Ζ ί	Ζ _L (Ω)
470	28	4	< 0,32	> 11	< 0,26	> 55	1,7 + j1,8	8 + j26
470	28	4	typ. 0,23	typ. 12,5	typ. 0,25	typ. 58	_	_



List of components:

- C1 = C5 = C6 = 1,4 to 5,5 pF film dielectric trimmer (cat. no. 2222 809 09001)
- C2 = 2 to 9 pF film dielectric trimmer (cat. no. 2222 809 09002)
- C3 = 100 pF feed-through capacitor
- C4 = 100 nF polyester capacitor
- L1 = stripline (34,8 mm \times 6,0 mm)
- L2 = 320 nH; 13 turns closely wound enamelled Cu wire (0,5 mm); int. dia. 4 mm; leads 2 × 4 mm
- L3 = L7 = Ferroxcube wide-band h.f. choke, grade 3B (cat. no. 4312 020 36640)
- L4 = stripline (12,0 mm \times 6,0 mm)
- L5 = 265 nH; 13 turns closely wound enamelled Cu wire (0,35 mm); int. dia. 3,5 mm; leads 2 × 4 mm
- L6 = 29 nH; 3 turns closely wound enamelled Cu wire (1 mm); int. dia. 3,5 mm; leads 2 × 4 mm

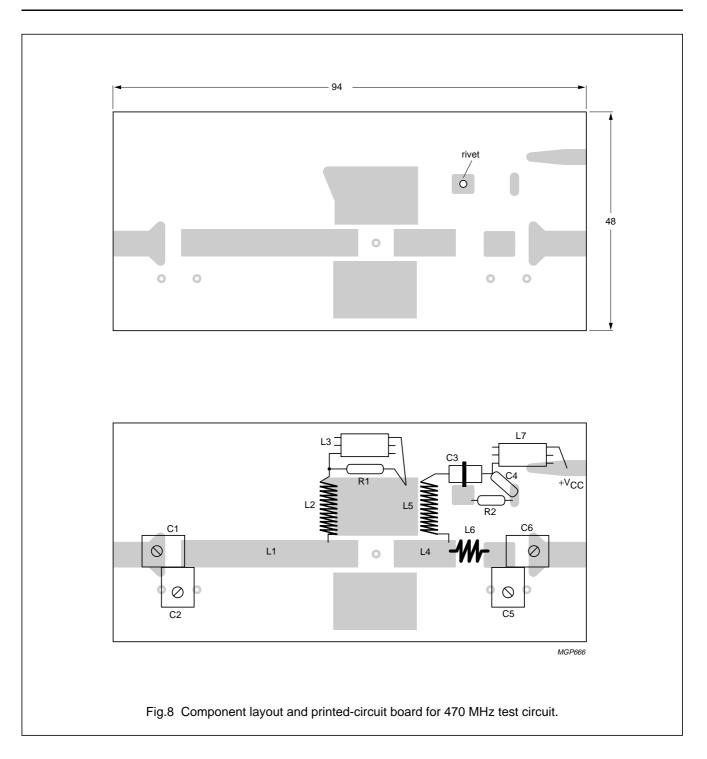
L1 and L4 are striplines on a double Cu-clad printed-circuit board with PTFE fibre-glass dielectric ($\epsilon_r = 2,74$); thickness 1/16".

R1 = 100Ω carbon resistor

R2 = 10Ω carbon resistor

Component layout and printed-circuit board for 470 MHz test circuit are shown in Fig.8.

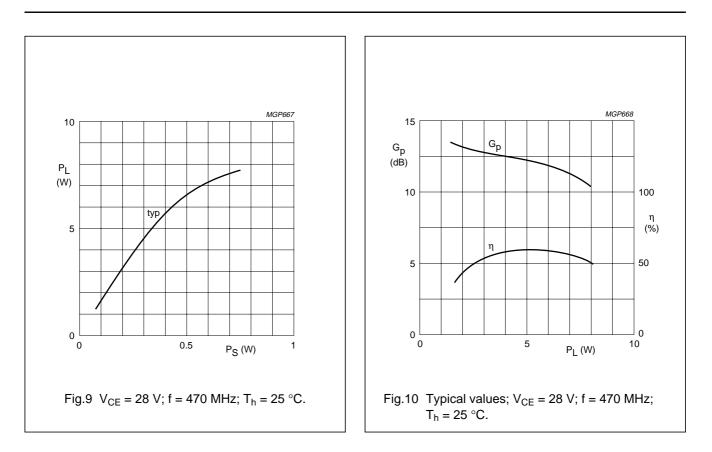




The circuit and the components are situated on one side of the PTFE fibre-glass board, the other side being fully metallized to serve as earth. Earth connections are made by means of hollow rivets, whilst under the emitter leads Cu straps are used for a direct contact between upper and lower sheets.

BLW90

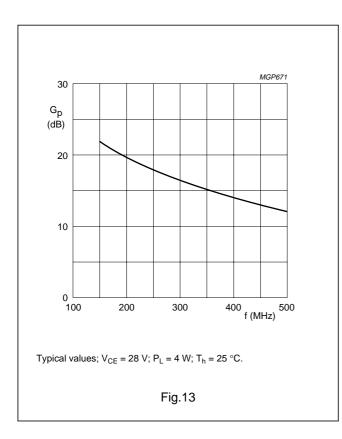
UHF power transistor

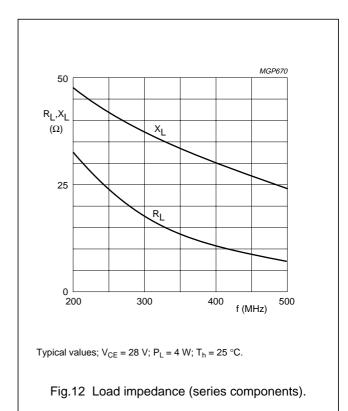


BLW90

UHF power transistor

MGP669 f_{i}, x_{i} (B) (B)





Ruggedness

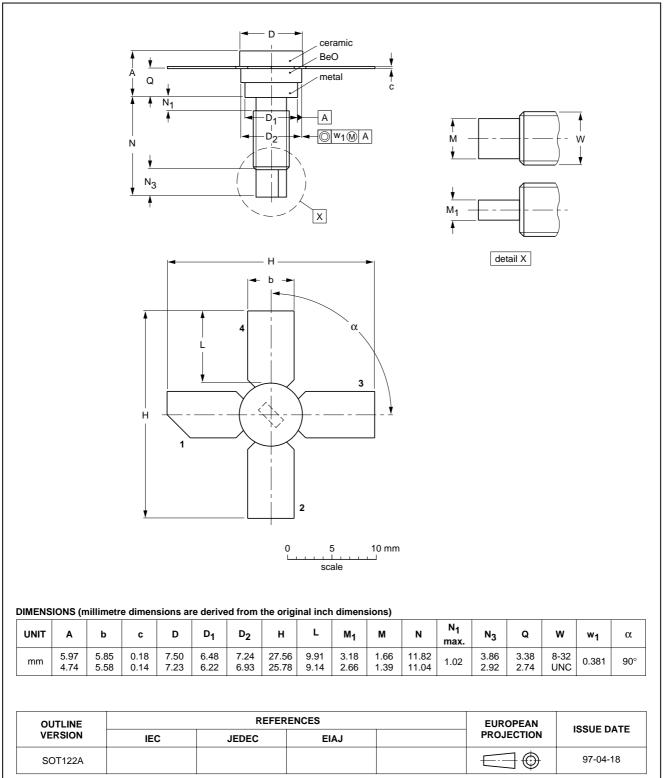
The BLW90 is capable of withstanding full load mismatch (VSWR = 50 through all phases) up to 4 W under the following conditions:

 V_{CE} = 28 V; f = 470 MHz; T_{h} = 70 °C; $R_{th\ mb\text{-}h}$ = 0,6 K/W.

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PACKAGE OUTLINE

Studded ceramic package; 4 leads



BLW90

SOT122A

BLW90

DEFINITIONS

Data Sheet Status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values				
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.				

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

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